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Details

Product Status	Not For New Designs
Core Processor	CPU32
Core Size	32-Bit Single-Core
Speed	25MHz
Connectivity	CANbus, EBI/EMI, SCI, SPI
Peripherals	POR, PWM, WDT
Number of I/O	18
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	7.5K x 8
Voltage - Supply (Vcc/Vdd)	4.75V ~ 5.25V
Data Converters	A/D 16x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	160-BQFP
Supplier Device Package	160-QFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/sc68376bgvab25



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SECTION 10 CONFIGURABLE TIMER MODULE 4

Table 3-1 MC68336/376 Pin Characteristics

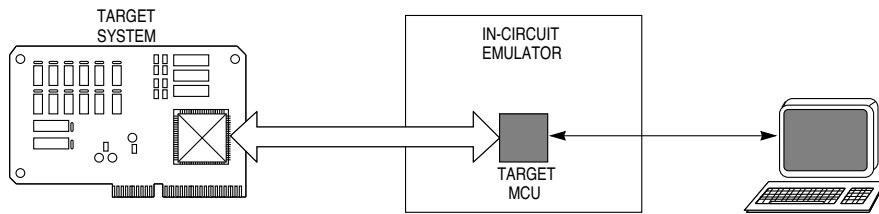
Pin Mnemonic	Output Driver	Input Synchronized	Input Hysteresis	Discrete I/O	Port Designation
ADDR23/CS10/ECLK	A	Yes	No	O	—
ADDR[22:19]/CS[9:6]	A	Yes	No	O	PC[6:3]
ADDR[18:0]	A	Yes	No	—	—
AN[51:48]	—	Yes ¹	Yes	I	PQB[7:4]
AN[3:0]/AN[w, x, y, z]	—	Yes ¹	Yes	I	PQB[3:0]
AN[59:57]	Ba	Yes	Yes	I/O	PQA[7:5]
AN[56:55]/ETRIG[2:1]	Ba	Yes	Yes	I/O	PQA[4:3]
AN[54:52]/MA[2:0]	Ba	Yes	Yes	I/O	PQA[2:0]
\overline{AS}	B	Yes	Yes	I/O	PE5
\overline{AVEC}	B	Yes	No	I/O	PE2
BERR	B	Yes	No	—	—
BG/CS1	B	—	—	—	—
BGACK/CS2	B	Yes	No	—	—
BKPT/DSCLK	—	Yes	Yes	—	—
BR/CS0	B	Yes	No	O	—
CLKOUT	A	—	—	—	—
CANRX0 (MC68376 Only)	—	Yes	Yes	—	—
CANTX0 (MC68376 Only)	Bo	—	—	—	—
\overline{CSBOOT}	B	—	—	—	—
CTD[10:9]/[4:3]	A	Yes	Yes	I/O	—
CPWM[8:5]	A	—	—	O	—
CTM2C	—	Yes	Yes	I	—
DATA[15:0]	Aw	Yes ¹	No	—	—
\overline{DS}	B	Yes	Yes	I/O	PE4
$\overline{DSACK}[1:0]$	B	Yes	No	I/O	PE[1:0]
EXTAL ²	—	—	Special	—	—
FC[2:0]/CS[5:3]	A	Yes	No	O	PC[2:0]
FREEZE/QUOT	A	—	—	—	—
\overline{IPIPE}/DSO	A	—	—	O	—
IFETCH/DSI	A	Yes	Yes	—	—
HALT	Bo	Yes	No	—	—
IRQ[7:1]	B	Yes	Yes	I/O	PF[7:1]
MISO	Bo	Yes ¹	Yes	I/O	PQS0
MODCLK	B	Yes ¹	Yes	I/O	PF0
MOSI	Bo	Yes ¹	Yes	I/O	PQS1
PCS0/ \overline{SS}	Bo	Yes ¹	Yes	I/O	PQS3
PCS[3:1]	Bo	Yes ¹	Yes	I/O	PQS[6:4]
R/ \overline{W}	A	Yes	No	—	—
RESET	Bo	Yes	Yes	—	—
\overline{RMC}	B	Yes	Yes	I/O	PE3
RXD	—	No	Yes	—	—
SCK	Bo	Yes ¹	Yes	I/O	PQS2

3.5 Signal Descriptions

The following tables define the MC68336/376 signals. **Table 3-4** shows signal origin, type, and active state. **Table 3-5** describes signal functions. Both tables are sorted alphabetically by mnemonic. MCU pins often have multiple functions. More than one description can apply to a pin.

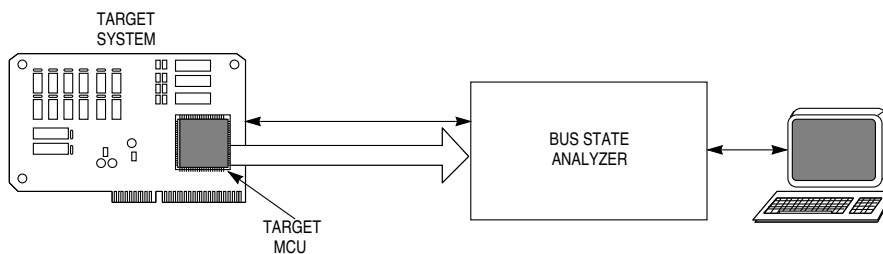
Table 3-4 MC68336/376 Signal Characteristics

Signal Name	MCU Module	Signal Type	Active State
ADDR[23:0]	SIM	Bus	—
AN[59:48]/[3:0]	QADC	Input	—
AN[w, x, y, z]	QADC	Input	—
AS	SIM	Output	0
AVEC	SIM	Input	0
BERR	SIM	Input	0
BG	SIM	Output	0
BGACK	SIM	Input	0
BKPT	CPU32	Input	0
BR	SIM	Input	0
CLKOUT	SIM	Output	—
CANRX0 (MC68376 Only)	TouCAN	Input	—
CANTX0 (MC68376 Only)	TouCAN	Output	—
CS[10:0]	SIM	Output	0
CSBOOT	SIM	Output	0
CPWM[8:5]	CTM4	Output	—
CTD[10:9]/[4:3]	CTM4	Input/Output	—
CTM2C	CTM4	Input	—
DATA[15:0]	SIM	Bus	—
DS	SIM	Output	0
DSACK[1:0]	SIM	Input	0
DSCLK	CPU32	Input	Serial Clock
DSI	CPU32	Input	Serial Data
DSO	CPU32	Output	Serial Data
ECLK	SIM	Output	—
ETRIG[2:1]	QADC	Input	—
EXTAL	SIM	Input	—
FC[2:0]	SIM	Output	—
FREEZE	SIM	Output	1
HALT	SIM	Input/Output	0
IFETCH	CPU32	Output	0
IPIPE	CPU32	Output	0
IRQ[7:1]	SIM	Input	0
MA[2:0]	QADC	Output	1
MISO	QSM	Input/Output	—
MODCLK	SIM	Input	—
MOSI	QSM	Input/Output	—
PC[6:0]	SIM	Output	—
PCS[3:0]	QSM	Input/Output	—
PE[7:0]	SIM	Input/Output	—
PF[7:0]	SIM	Input/Output	—



1128A

Figure 4-8 Common In-Circuit Emulator Diagram



1129A

Figure 4-9 Bus State Analyzer Configuration

4.10.3 Enabling BDM

Accidentally entering BDM in a non-development environment can lock up the CPU32 when the serial command interface is not available. For this reason, BDM is enabled during reset via the breakpoint ($\overline{\text{BKPT}}$) signal.

BDM operation is enabled when $\overline{\text{BKPT}}$ is asserted (low), at the rising edge of $\overline{\text{RESET}}$. BDM remains enabled until the next system reset. A high $\overline{\text{BKPT}}$ signal on the trailing edge of $\overline{\text{RESET}}$ disables BDM. $\overline{\text{BKPT}}$ is latched again on each rising transition of $\overline{\text{RESET}}$. $\overline{\text{BKPT}}$ is synchronized internally, and must be held low for at least two clock cycles prior to negation of $\overline{\text{RESET}}$.

BDM enable logic must be designed with special care. If hold time on $\overline{\text{BKPT}}$ (after the trailing edge of $\overline{\text{RESET}}$) extends into the first bus cycle following reset, the bus cycle could inadvertently be tagged with a breakpoint. Refer to the *SIM Reference Manual* (SIMRM/AD) for timing information.

4.10.4 BDM Sources

When BDM is enabled, any of several sources can cause the transition from normal mode to BDM. These sources include external breakpoint hardware, the BGND instruction, a double bus fault, and internal peripheral breakpoints. If BDM is not enabled when an exception condition occurs, the exception is processed normally.

Table 5-20 Block Size Encoding

BLKSZ[2:0]	Block Size	Address Lines Compared
000	2 Kbytes	ADDR[23:11]
001	8 Kbytes	ADDR[23:13]
010	16 Kbytes	ADDR[23:14]
011	64 Kbytes	ADDR[23:16]
100	128 Kbytes	ADDR[23:17]
101	256 Kbytes	ADDR[23:18]
110	512 Kbytes	ADDR[23:19]
111	1 Mbyte	ADDR[23:20]

The chip-select address compare logic uses only the most significant bits to match an address within a block. The value of the base address must be an integer multiple of the block size.

After reset, the MCU fetches the initialization routine from the address contained in the reset vector, located beginning at address \$000000 of program space. To support bootstrap operation from reset, the base address field in the boot chip-select base address register (CSBARBT) has a reset value of \$000, which corresponds to a base address of \$000000 and a block size of one Mbyte. A memory device containing the reset vector and initialization routine can be automatically enabled by $\overline{\text{CSBOOT}}$ after a reset. Refer to **5.9.4 Chip-Select Reset Operation** for more information.

5.9.1.3 Chip-Select Option Registers

Option register fields determine timing of and conditions for assertion of chip-select signals. To assert a chip-select signal, and to provide $\overline{\text{DSACK}}$ or autovector support, other constraints set by fields in the option register and in the base address register must also be satisfied. The following paragraphs summarize option register functions. Refer to **D.2.21 Chip-Select Option Registers** for register and bit field information.

The MODE bit determines whether chip-select assertion simulates an asynchronous bus cycle, or is synchronized to the M6800-type bus clock signal ECLK available on ADDR23. Refer to **5.3 System Clock** for more information on ECLK.

BYTE[1:0] controls bus allocation for chip-select transfers. Port size, set when a chip-select is enabled by a pin assignment register, affects signal assertion. When an 8-bit port is assigned, any BYTE field value other than %00 enables the chip-select signal. When a 16-bit port is assigned, however, BYTE field value determines when the chip-select is enabled. The BYTE fields for $\overline{\text{CS}}[10:0]$ are cleared during reset. However, both bits in the boot ROM chip-select option register (CSORBT) BYTE field are set (%11) when the $\overline{\text{RESET}}$ signal is released.

$\text{R}/\overline{\text{W}}[1:0]$ causes a chip-select signal to be asserted only for a read, only for a write, or for both read and write. Use this field in conjunction with the STRB bit to generate asynchronous control signals for external devices.



6.6 Reset

Reset places the SRAM in low-power stop mode, enables program space access, and clears the base address registers and the register lock bit. These actions make it possible to write a new base address into the registers.

When a synchronous reset occurs while a byte or word SRAM access is in progress, the access is completed. If reset occurs during the first word access of a long-word operation, only the first word access is completed. If reset occurs during the second word access of a long-word operation, the entire access is completed. Data being read from or written to the RAM may be corrupted by asynchronous reset. Refer to **5.7 Reset** for more information about resets.

9.2.2 QSM Pin Control Registers

The QSM uses nine pins. Eight of the pins can be used for serial communication or for parallel I/O. Clearing a bit in the port QS pin assignment register (PQSPAR) assigns the corresponding pin to general-purpose I/O; setting a bit assigns the pin to the QSPI. PQSPAR does not select I/O. In master mode, PQSPAR causes a bit to be assigned to the QSPI when SPE is set. In slave mode, the MISO pin, if assigned to the QSPI, remains under the control of the QSPI, regardless of the SPE bit. PQSPAR does not affect operation of the SCI.

The port QS data direction register (DDRQS) determines whether pins are inputs or outputs. Clearing a bit makes the corresponding pin an input; setting a bit makes the pin an output. DDRQS affects both QSPI function and I/O function. DDQS7 determines the direction of the TXD pin only when the SCI transmitter is disabled. When the SCI transmitter is enabled, the TXD pin is an output. PQSPAR and DDRQS are 8-bit registers located at the same word address. **Table 9-1** is a summary of QSM pin functions.

The port QS data register (PORTQS) latches I/O data. PORTQS writes drive pins defined as outputs. PORTQS reads return data present on the pins. To avoid driving undefined data, first write PORTQS, then configure DDRQS.

Table 9-1 Effect of DDRQS on QSM Pin Function

QSM Pin	Mode	DDRQS Bit	Bit State	Pin Function
MISO	Master	DDQS0	0	Serial data input to QSPI
			1	Disables data input
	Slave		0	Disables data output
			1	Serial data output from QSPI
MOSI	Master	DDQS1	0	Disables data output
			1	Serial data output from QSPI
	Slave		0	Serial data input to QSPI
			1	Disables data input
SCK ¹	Master	DDQS2	—	Clock output from QSPI
	Slave		—	Clock input to QSPI
PCS0/SS	Master	DDQS3	0	Assertion causes mode fault
			1	Chip-select output
	Slave		0	QSPI slave select input
			1	Disables slave select input
PCS[1:3]	Master	DDQS[4:6]	0	Disables chip-select output
			1	Chip-select output
	Slave		0	Inactive
			1	Inactive
TXD ²	—	DDQS7	X	Serial data output from SCI
RXD	—	None	NA	Serial data input to SCI

NOTES:

1. PQS2 is a digital I/O pin unless the SPI is enabled (SPE set in SPCR1), in which case it becomes the QSPI serial clock SCK.
2. PQS7 is a digital I/O pin unless the SCI transmitter is enabled (TE set in SCCR1), in which case it becomes the SCI serial data output TXD.

Normally, the SPI bus performs synchronous bidirectional transfers. The serial clock on the SPI bus master supplies the clock signal SCK to time the transfer of data. Four possible combinations of clock phase and polarity can be specified by the CPHA and CPOL bits in SPCR0.

Data is transferred with the most significant bit first. The number of bits transferred per command defaults to eight, but can be set to any value from eight to sixteen bits by writing a value into the BITSE field in command RAM.

Typically, SPI bus outputs are not open-drain unless multiple SPI masters are in the system. If needed, the WOMQ bit in SPCR0 can be set to provide wired-OR, open-drain outputs. An external pull-up resistor should be used on each output line. WOMQ affects all QSPI pins regardless of whether they are assigned to the QSPI or used as general-purpose I/O.

9.3.5.1 Master Mode

Setting the MSTR bit in SPCR0 selects master mode operation. In master mode, the QSPI can initiate serial transfers, but cannot respond to externally initiated transfers. When the slave select input of a device configured for master mode is asserted, a mode fault occurs.

Before QSPI operation begins, QSM register PQSPAR must be written to assign the necessary pins to the QSPI. The pins necessary for master mode operation are MISO and MOSI, SCK, and one or more of the chip-select pins. MISO is used for serial data input in master mode, and MOSI is used for serial data output. Either or both may be necessary, depending on the particular application. SCK is the serial clock output in master mode.

The PORTQS data register must next be written with values that make the PQS2/SCK and PQS[6:3]/PCS[3:0] outputs inactive when the QSPI completes a series of transfers. Pins allocated to the QSPI by PQSPAR are controlled by PORTQS when the QSPI is inactive. PORTQS I/O pins driven to states opposite those of the inactive QSPI signals can generate glitches that momentarily enable or partially clock a slave device. Thus, if a slave device operates with an inactive SCK state of logic one (CPOL = 1) and uses active low peripheral chip-select PCS0, the PQS[3:2] bits in PORTQS must be set to %11. If PQS[3:2] = %00, falling edges will appear on PQS2/SCK and PQS3/PCS0 as the QSPI relinquishes control of these pins and PORTQS drives them to logic zero from the inactive SCK and PCS0 states of logic one.

Before master mode operation is initiated, QSM register DDRQS is written last to direct the data flow on the QSPI pins used. Configure the SCK, MOSI and appropriate chip-select pins PCS[3:0] as outputs. The MISO pin must be configured as an input.

After pins are assigned and configured, write appropriate data to the command queue. If data is to be transmitted, write the data to transmit RAM. Initialize the queue pointers as appropriate.

Data transfer is synchronized with the internally-generated serial clock SCK. Control bits, CPHA and CPOL, in SPCR0, control clock phase and polarity. Combinations of CPHA and CPOL determine upon which SCK edge to drive outgoing data from the MOSI pin and to latch incoming data from the MISO pin.

9.4.1.2 Status Register

SCSR contains flags that show SCI operating conditions. These flags are cleared either by SCI hardware or by reading SCSR, then reading or writing SCDR. A long-word read can consecutively access both SCSR and SCDR. This action clears receiver status flag bits that were set at the time of the read, but does not clear TDRE or TC flags.

If an internal SCI signal for setting a status bit comes after reading the asserted status bits, but before reading or writing SCDR, the newly set status bit is not cleared. SCSR must be read again with the bit set, and SCDR must be read or written before the status bit is cleared.

Reading either byte of SCSR causes all 16 bits to be accessed, and any status bit already set in either byte is cleared on a subsequent read or write of SCDR.

9.4.1.3 Data Register

SCDR contains two data registers at the same address. The receive data register (RDR) is a read-only register that contains data received by the SCI serial interface. Data enters the receive serial shifter and is transferred to RDR. The transmit data register (TDR) is a write-only register that contains data to be transmitted. Data is first written to TDR, then transferred to the transmit serial shifter, where additional format bits are added before transmission. R[7:0]/T[7:0] contain either the first eight data bits received when SCDR is read, or the first eight data bits to be transmitted when SCDR is written. R8/T8 are used when the SCI is configured for 9-bit operation. When it is configured for 8-bit operation, they have no meaning or effect.

9.4.2 SCI Pins

Two unidirectional pins, TXD (transmit data) and RXD (receive data), are associated with the SCI. TXD can be used by the SCI or for general-purpose I/O. Function is assigned by the port QS pin assignment register (PQSPAR). The receive data (RXD) pin is dedicated to the SCI. **Table 9-4** shows SCI pin function.

Table 9-4 SCI Pins

Pin Names	Mnemonics	Mode	Function
Receive Data	RXD	Receiver disabled Receiver enabled	Not used Serial data input to SCI
Transmit Data	TXD	Transmitter disabled Transmitter enabled	General-purpose I/O Serial data output from SCI

9.4.3 SCI Operation

SCI operation can be polled by means of status flags in SCSR, or interrupt-driven operation can be employed by the interrupt enable bits in SCCR1.

8.4.3 External Trigger Input Pins

The QADC has two external trigger pins (ETRIG[2:1]). The external trigger pins share two multifunction port A pins (PQA[4:3]), which are normally used as analog channel input pins. Each of the two external trigger pins is associated with one of the scan queues. When a queue is in external trigger mode, the corresponding external trigger pin is configured as a digital input and the software programmed input/output direction for that pin is ignored. Refer to **D.5.5 Port Data Direction Register** for more information.

8.4.4 Multiplexed Address Output Pins

In non-multiplexed mode, the 16 channel pins are connected to an internal multiplexer which routes the analog signals into the A/D converter.

In externally multiplexed mode, the QADC allows automatic channel selection through up to four external 1-of-8 multiplexer chips. The QADC provides a 3-bit multiplexed address output to the external mux chips to allow selection of one of eight inputs. The multiplexed address output signals MA[2:0] can be used as multiplex address output bits or as general-purpose I/O.

MA[2:0] are used as the address inputs for up to four 1-of-8 multiplexer chips (for example, the MC14051 and the MC74HC4051). Since MA[2:0] are digital outputs in multiplexed mode, the software programmed input/output direction for these pins in DDRQA is ignored.

8.4.5 Multiplexed Analog Input Pins

In externally multiplexed mode, four of the port B pins are redefined to each represent a group of eight input channels. Refer to **Table 8-1**.

The analog output of each external multiplexer chip is connected to one of the AN[w, x, y, z] inputs in order to convert a channel selected by the MA[2:0] multiplexed address outputs.

Table 8-1 Multiplexed Analog Input Channels

Multiplexed Analog Input	Channels
ANw	Even numbered channels from 0 to 14
ANx	Odd numbered channels from 1 to 15
ANy	Even channels from 16 to 30
ANz	Odd channels from 17 to 31

8.4.6 Voltage Reference Pins

V_{RH} and V_{RL} are the dedicated input pins for the high and low reference voltages. Separating the reference inputs from the power supply pins allows for additional external filtering, which increases reference voltage precision and stability, and subsequently contributes to a higher degree of conversion accuracy. Refer to **Tables A-11** and **A-12** for more information.

When the QADC encounters a CCW with the pause bit set, the queue enters the paused state after completing the conversion specified in the CCW with the pause bit. The pause flag is set and a pause software interrupt may optionally be issued. The status of the queue is shown to be paused, indicating completion of a subqueue. The QADC then waits for another trigger event to again begin execution of the next subqueue.

8.12.2 Queue Boundary Conditions

A queue boundary condition occurs when one or more of the queue operating parameters is configured in a way that will inhibit queue execution. One such boundary condition is when the first CCW in a queue specified channel 63, the end-of-queue (EOQ) code. In this case, the queue becomes active and the first CCW is read. The EOQ code is recognized, the completion flag is set, and the queue becomes idle. A conversion is not performed.

A similar situation occurs when BQ2 (beginning of queue 2 pointer) is set beyond the end of the CCW table (between \$28 and \$3F) and a trigger event occurs for queue 2. The EOQ condition is recognized immediately, the completion flag is set, and the queue becomes idle. A conversion is not performed.

The QADC behaves the same way when BQ2 is set to CCW0 and a trigger event occurs for queue 1. After reading CCW0, the EOQ condition is recognized, the completion flag is set, and the queue becomes idle. A conversion is not performed.

Multiple EOQ conditions may be recognized simultaneously, but the QADC will not behave differently. One example is when BQ2 is set to CCW0, CCW0 contains the EOQ code, and a trigger event occurs for queue 1. The QADC will read CCW0 and recognize the queue 1 trigger event, detecting both as EOQ conditions. The completion flag will be set and queue 1 will become idle.

Boundary conditions also exist for combinations of pause and end-of-queue. One case is when a pause bit is in one CCW and an end-of-queue condition is in the next CCW. The conversion specified by the CCW with the pause bit set completes normally. The pause flag is set. However, since the end-of-queue condition is recognized, the completion flag is also set and the queue status becomes idle, not paused. Examples of this situation include:

- The pause bit is set in CCW5 and the channel 63 (EOQ) code is in CCW6.
- The pause bit is set in CCW27.
- During queue 1 operation, the pause bit is set in CCW14 and BQ2 points to CCW15.

Another pause and end-of-queue boundary condition occurs when the pause and an end-of-queue condition occur in the same CCW. Both the pause and end-of-queue conditions are recognized simultaneously. The end-of-queue condition has precedence so a conversion is not performed for the CCW and the pause flag is not set. The QADC sets the completion flag and the queue status becomes idle. Examples of this situation are:

Table 13-5 Standard Format Frames

Field	Description
16-Bit Time Stamp	The ID LOW word, which is not needed for standard format, is used in a standard format buffer to store the 16-bit value of the free-running timer which is captured at the beginning of the identifier field of the frame on the CAN bus.
ID[28:18]	Contains bits [28:18] of the identifier, located in the ID HIGH word of the message buffer. The four least significant bits in this register (corresponding to the IDE bit and ID[17:15] for an extended identifier message) must all be written as logic zeros to ensure proper operation of the TouCAN.
RTR	This bit is located in the ID HIGH word of the message buffer; 0 = data frame, 1 = remote frame.
RTR/SRR Bit Treatment	If the TouCAN transmits this bit as a one and receives it as a zero, an "arbitration loss" is indicated. If the TouCAN transmits this bit as a zero and is receives it as a one, a bit error is indicated. If the TouCAN transmits a value and receives a matching response, a successful bit transmission is indicated.

13.4.1.4 Serial Message Buffers

To allow double buffering of messages, the TouCAN has two shadow buffers called serial message buffers. These two buffers are used by the TouCAN for buffering both received messages and messages to be transmitted. Only one serial message buffer is active at a time, and its function depends upon the operation of the TouCAN at that time. At no time does the user have access to or visibility of these two buffers.

13.4.1.5 Message Buffer Activation/Deactivation Mechanism

Each message buffer must be activated once it is configured for the desired operation by the user. A buffer is activated by writing the appropriate code to the control/status word for that buffer. Once the buffer is activated, it will begin participating in the normal transmit and receive processes.

Likewise, a buffer is deactivated by writing the appropriate deactivation code to the control/status word for that buffer. Deactivation of a buffer is typically done when the user desires to reconfigure the buffer, for example to change the buffer's function (RX to TX or TX to RX). Deactivation should also be done before changing a receive buffer's message identifier or before loading a new message to be transmitted into a transmit buffer.

For more details on activation and deactivation of message buffers, and the effects on message buffer operation, refer to **13.5 TouCAN Operation**.

13.4.1.6 Message Buffer Lock/Release/Busy Mechanism

In addition to the activation/deactivation mechanism, the TouCAN also utilizes a lock/release/busy mechanism to assure data coherency during the receive process. The mechanism includes a lock status for each message buffer, and utilizes the two serial message buffers to facilitate frame transfers within the TouCAN.

Reading the control/status word of a receive message buffer triggers the lock for that buffer. While locked, a received message cannot be transferred into that buffer from one of the SMBs.

Table A-6 AC Timing (Continued)
 $(V_{DD} \text{ and } V_{DDSYN} = 5.0 \text{ Vdc} \pm 5\%, V_{SS} = 0 \text{ Vdc}, T_A = T_L \text{ to } T_H)^1$

Num	Characteristic	Symbol	Min	Max	Unit
26	Data Out Valid to \overline{DS} , \overline{CS} Asserted (Write)	t_{DVSA}	10	—	ns
27	Data In Valid to Clock Low (Data Setup) ⁵	t_{DICL}	5	—	ns
27A	Late \overline{BERR} , \overline{HALT} Asserted to Clock Low (Setup Time)	t_{BELCL}	15	—	ns
28	\overline{AS} , \overline{DS} Negated to $\overline{DSACK}[1:0]$, \overline{BERR} , \overline{HALT} , \overline{AVEC} Negated	t_{SNDN}	0	60	ns
29	\overline{DS} , \overline{CS} Negated to Data In Invalid (Data In Hold) ⁸	t_{SNDI}	0	—	ns
29A	\overline{DS} , \overline{CS} Negated to Data In High Impedance ^{8, 9}	t_{SHDI}	—	48	ns
30	CLKOUT Low to Data In Invalid (Fast Cycle Hold) ⁸	t_{CLDI}	10	—	ns
30A	CLKOUT Low to Data In High Impedance ⁸	t_{CLDH}	—	72	ns
31	$\overline{DSACK}[1:0]$ Asserted to Data In Valid ¹⁰	t_{DADI}	—	46	ns
33	Clock Low to \overline{BG} Asserted/Negated	t_{CLBAN}	—	23	ns
35	\overline{BR} Asserted to \overline{BG} Asserted (RMC Not Asserted) ¹¹	t_{BRAGA}	1	—	t_{cyc}
37	\overline{BGACK} Asserted to \overline{BG} Negated	t_{GAGN}	1	2	t_{cyc}
39	\overline{BG} Width Negated	t_{GH}	2	—	t_{cyc}
39A	\overline{BG} Width Asserted	t_{GA}	1	—	t_{cyc}
46	R/\overline{W} Width Asserted (Write or Read)	t_{RWA}	115	—	ns
46A	R/\overline{W} Width Asserted (Fast Write or Read Cycle)	t_{RWAS}	70	—	ns
47A	Asynchronous Input Setup Time \overline{BR} , \overline{BGACK} , $\overline{DSACK}[1:0]$, \overline{BERR} , \overline{AVEC} , \overline{HALT}	t_{AIST}	5	—	ns
47B	Asynchronous Input Hold Time	t_{AIHT}	12	—	ns
48	$\overline{DSACK}[1:0]$ Asserted to \overline{BERR} , \overline{HALT} Asserted ¹²	t_{DABA}	—	30	ns
53	Data Out Hold from Clock High	t_{DOCH}	0	—	ns
54	Clock High to Data Out High Impedance	t_{CHDH}	—	23	ns
55	R/\overline{W} Asserted to Data Bus Impedance Change	t_{RADC}	32	—	ns
56	\overline{RESET} Pulse Width (Reset Instruction)	t_{HRPW}	512	—	t_{cyc}
57	\overline{BERR} Negated to \overline{HALT} Negated (Rerun)	t_{BNHN}	0	—	ns
70	Clock Low to Data Bus Driven (Show)	t_{SCLDD}	0	23	ns
71	Data Setup Time to Clock Low (Show)	t_{SCLDS}	10	—	ns
72	Data Hold from Clock Low (Show)	t_{SCLDH}	10	—	ns
73	\overline{BKPT} Input Setup Time	t_{BKST}	10	—	ns
74	\overline{BKPT} Input Hold Time	t_{BKHT}	10	—	ns
75	Mode Select Setup Time	t_{MSS}	20	—	t_{cyc}



This field only affects the response of chip-selects and does not affect interrupt recognition by the CPU32.

$\overline{\text{AVEC}}$ — Autovector Enable

This field selects one of two methods of acquiring an interrupt vector during an interrupt acknowledge cycle. It is not usually used with a chip-select pin.

0 = External interrupt vector enabled

1 = Autovector enabled

If the chip select is configured to trigger on an interrupt acknowledge cycle ($\text{SPACE}[1:0] = \%00$) and the $\overline{\text{AVEC}}$ field is set to one, the chip-select automatically generates $\overline{\text{AVEC}}$ in response to the interrupt acknowledge cycle. Otherwise, the vector must be supplied by the requesting device.

D.2.22 Master Shift Registers

TSTMSRA — Master Shift Register A

\$YFFFA30

Used for factory test only.

TSTMSRB — Master Shift Register B

\$YFFFA32

Used for factory test only.

D.2.23 Test Module Shift Count Register

TSTSC — Test Module Shift Count

\$YFFFA34

Used for factory test only.

D.2.24 Test Module Repetition Count Register

TSTRC — Test Module Repetition Count

\$YFFFA36

Used for factory test only.

D.2.25 Test Submodule Control Register

CREG — Test Submodule Control Register

\$YFFFA38

Used for factory test only.

D.2.26 Distributed Register

DREG — Distributed Register

\$YFFFA3A

Used for factory test only.

SCBR[12:0] — SCI Baud Rate

SCI baud rate is programmed by writing a 13-bit value to this field. Writing a value of zero to SCBR disables the baud rate generator. Baud clock rate is calculated as follows:

$$\text{SCI Baud Rate} = \frac{f_{\text{sys}}}{32 \times \text{SCBR}[12:0]}$$

or

$$\text{SCBR}[12:0] = \frac{f_{\text{sys}}}{32 \times \text{SCI Baud Rate Desired}}$$

where SCBR[12:0] is in the range of 1 to 8191.

D.6.6 SCI Control Register 1

SCCR1 — SCI Control Register 1

\$YFFC0A

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	LOOPS	WOMS	ILT	PT	PE	M	WAKE	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
RESET:															
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

SCCR1 contains SCI configuration parameters, including transmitter and receiver enable bits, interrupt enable bits, and operating mode enable bits. SCCR0 can be read or written at any time. The SCI can modify the RWU bit under certain circumstances. Changing the value of SCCR1 bits during a transfer operation can disrupt the transfer.

Bit 15 — Not Implemented

LOOPS — Loop Mode

- 0 = Normal SCI operation, no looping, feedback path disabled.
- 1 = Test SCI operation, looping, feedback path enabled.

WOMS — Wired-OR Mode for SCI Pins

- 0 = If configured as an output, TXD is a normal CMOS output.
- 1 = If configured as an output, TXD is an open-drain output.

ILT — Idle-Line Detect Type

- 0 = Short idle-line detect (start count on first one).
- 1 = Long idle-line detect (start count on first one after stop bit(s)).

PT — Parity Type

- 0 = Even parity
- 1 = Odd parity

PE — Parity Enable

- 0 = SCI parity disabled.
- 1 = SCI parity enabled.

BITS[3:0] — Bits Per Transfer

In master mode, when BITSE is set in a command RAM byte, BITS[3:0] determines the number of data bits transferred. When BITSE is cleared, eight bits are transferred. Reserved values default to eight bits. In slave mode, the command RAM is not used and the setting of BITSE has no effect on QSPI transfers. Instead, the BITS[3:0] field determines the number of bits the QSPI will receive during each transfer before storing the received data.

Table D-34 shows the number of bits per transfer.

Table D-34 Bits Per Transfer

BITS[3:0]	Bits per Transfer
0000	16
0001	Reserved
0010	Reserved
0011	Reserved
0100	Reserved
0101	Reserved
0110	Reserved
0111	Reserved
1000	8
1001	9
1010	10
1011	11
1100	12
1101	13
1110	14
1111	15

CPOL — Clock Polarity

0 = The inactive state of SCK is logic zero.

1 = The inactive state of SCK is logic one.

CPOL is used to determine the inactive state of the serial clock (SCK). It is used with CPHA to produce a desired clock/data relationship between master and slave devices.

CPHA — Clock Phase

0 = Data is captured on the leading edge of SCK and changed on the trailing edge of SCK.

1 = Data is changed on the leading edge of SCK and captured on the trailing edge of SCK

CPHA determines which edge of SCK causes data to change and which edge causes data to be captured. CPHA is used with CPOL to produce a desired clock/data relationship between master and slave devices.

SPBR[7:0] — Serial Clock Baud Rate

The QSPI uses a modulus counter to derive the SCK baud rate from the MCU system clock. Baud rate is selected by writing a value from 2 to 255 into SPBR[7:0]. The following equation determines the SCK baud rate:



CHBK — Channel Register Breakpoint Flag

CHBK is asserted if a breakpoint occurs because of a CHAN register match with the CHAN register breakpoint register. CHBK is negated when the BKPT flag is cleared.

SRBK — Service Request Breakpoint Flag

SRBK is asserted if a breakpoint occurs because of any of the service request latches being asserted along with their corresponding enable flag in the development support control register. SRBK is negated when the BKPT flag is cleared.

TPUF — TPU FREEZE Flag

TPUF is set whenever the TPU is in a halted state as a result of FREEZE being asserted. This flag is automatically negated when the TPU exits the halted state because of FREEZE being negated.

D.8.5 TPU Interrupt Configuration Register

TICR — TPU Interrupt Configuration Register

\$YFFE08

15	10	9	8	7	6	5	4	3	0
NOT USED		CIRL[2:0]			CIBV[3:0]			NOT USED	
RESET:									
		0	0	0	0	0	0	0	

CIRL[2:0] — Channel Interrupt Request Level

This three-bit field specifies the interrupt request level for all channels. Level seven for this field indicates a non-maskable interrupt; level zero indicates that all channel interrupts are disabled.

CIBV[3:0] — Channel Interrupt Base Vector

The TPU is assigned 16 unique interrupt vector numbers, one vector number for each channel. The CIBV field specifies the most significant nibble of all 16 TPU channel interrupt vector numbers. The lower nibble of the TPU interrupt vector number is determined by the channel number on which the interrupt occurs.

D.8.6 Channel Interrupt Enable Register

CIER — Channel Interrupt Enable Register

\$YFFE0A

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CH 15	CH 14	CH 13	CH 12	CH 11	CH 10	CH 9	CH 8	CH 7	CH 6	CH 5	CH 4	CH 3	CH 2	CH 1	CH 0
RESET:															
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

CH[15:0] — Channel Interrupt Enable/Disable

0 = Channel interrupts disabled

1 = Channel interrupts enabled



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